502538849 10/21/2013

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KOJI FUJIMOTO	08/26/2013
EMI MATSUSHITA	08/26/2013
HITOSHI KUROMI	08/30/2013
TARO UENO	08/26/2013
YOSHIHIRO KOSHIDO	08/30/2013

RECEIVING PARTY DATA

Name:	MURATA MANUFACTURING CO., LTD.
Street Address:	10-1, HIGASHIKOTARI 1-CHOME
City:	NAGAOKAKYO-SHI, KYOTO-FU
State/Country:	JAPAN
Postal Code:	617-8555

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14049320

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	M1071.3272
NAME OF SUBMITTER:	RICHARD LACAVA

502538849 REEL: 031441 FRAME: 0246

PATENT

OP \$40.00 14049320

Signature:	/Richard LaCava/
Date:	10/21/2013
Total Attachments: 1 source=M1071_3272_Assignment#page1.tif	

PATENT REEL: 031441 FRAME: 0247 WHEREAS, I, Koji Fujimoto, Emi Matsushita, Hitoshi Kuromi, Taro Ueno, and Yoshihiro Koshido, as assignors, have invented certain improvements in a SOLID-STATE ELECTROLYTIC CAPACITOR MANUFACTURING METHOD AND SOLID-STATE ELECTROLYTIC CAPACITOR and for which an application for United States Letters Patent has been executed by me (us) of even date herewith; and

WHEREAS, Murata Manufacturing Co., Ltd. (Corporation of Japan) address: 10-1, Higashikotari 1-chome, Nagaokakyo-shi, Kyoto-fu 617-8555, Japan, as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: Augus 26, 2013	Koji Fizimoto
	Koji Fujimoto
Date: August 26. 2013	Em; Matsushita
Ų	Emi Matsushita
Date: <u>August</u> 30, 2013	Hitoshi Kuromi Hitoshi Kuromi
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Date: <u>August 26, 2013</u>	Taro Ueno
	Taro Ueno
Date: <u>August 30, 201</u> 3	Yoshihiro Koshido
Ø .	Yoshihiro Koshido

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